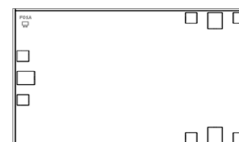


MMIC

Power Splitter/Combiner Die

EP2KA-D+

2 Way-0° 50Ω 10 to 43.5 GHz



The Big Deal

- Ultra-Wide Bandwidth, 10 to 43.5 GHz
- Excellent Amplitude Unbalance, 0.18 dB typ.

Product Overview

Mini-Circuits' EP2KA-D+ is a MMIC 2-way 0° splitter/combiner Die designed for wideband operation from 10 to 43.5 GHz. Manufactured using GaAs IPD technology, it provides a high level of ESD protection and excellent reliability.

Key Features

| Feature | Advantages |
|---|--|
| Wideband, 10 to 43.5 GHz | One power splitter can be used in many applications, saving component count. Also ideal for wideband applications such as military and instrument. |
| Excellent Amplitude Unbalance, 0.18 dB and Good Phase Unbalance, 3-6 deg. | Excellent Amplitude and phase unbalance helps to accurately divide the input signals which is essential in test and measurement circuits. |
| Unpackaged Die | Enables user to integrate it directly into hybrids. |



MMIC

Power Splitter/Combiner Die

EP2KA-D+

2 Way-0° 50Ω 10 to 43.5 GHz

Product Features

- Super wide bandwidth, 10 to 43.5 GHz
- Excellent amplitude unbalance, 0.18 dB typ.
- DC passing

Applications

- Military
- 5G
- Instrumentation



+RoHS Compliant

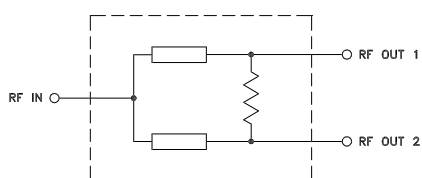
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Ordering Information: Refer to Last Page

General Description

Mini-Circuits' EP2KA-D+ is a MMIC 2-way 0° splitter/combiner Die designed for wideband operation from 10 to 43.5 GHz. Manufactured using GaAs IPD technology, it provides a high level of ESD protection and excellent reliability.

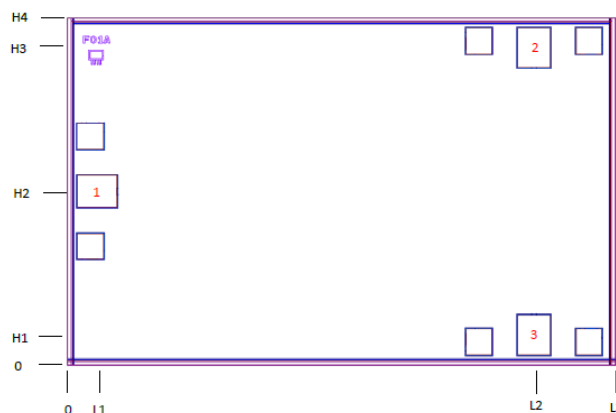
Simplified Schematic and Pad Description



| Pad# | Function |
|------------|-------------------|
| 1 | Sum Port (RF IN) |
| 2 | Port 1 (RF OUT 1) |
| 3 | Port 2 (RF OUT 2) |
| Die Bottom | Ground |

Note: 1. Bond Pad material - Gold
2. Bottom of Die is ground - Gold plated

Bonding Pad Position



Dimensions in μm , Typical

| L1 | L2 | L3 | H1 | H2 | H3 | H4 | Thickness | Width | Length | Bond Pad #1 Size | Bond Pad #2 Size |
|-----|------|------|-----|-----|------|------|-----------|-------|--------|------------------|------------------|
| 112 | 1704 | 2000 | 112 | 635 | 1158 | 1270 | 100 | 1270 | 2000 | 150 x 125 | 150 x 125 |



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Electrical Specifications at 25°C¹

| Parameter | Frequency (GHz) | Min. | Typ. | Max. | Unit |
|-----------------------------|-----------------|------|------|------|--------|
| Frequency Range | | 10 | | 43.5 | GHz |
| Insertion Loss above 3.0 dB | 10 - 20 | | 0.8 | | dB |
| | 20 - 25 | | 0.5 | | |
| | 25 - 30 | | 0.9 | | |
| | 30 - 40 | | 1.5 | | |
| | 40 - 43.5 | | 2.2 | | |
| Isolation | 10 - 20 | | 17 | | dB |
| | 20 - 25 | | 26 | | |
| | 25 - 30 | | 22 | | |
| | 30 - 40 | | 26 | | |
| | 40 - 43.5 | | 29 | | |
| Phase Unbalance | 10 - 20 | | 3.7 | | Degree |
| | 20 - 25 | | 4.7 | | |
| | 25 - 30 | | 6.1 | | |
| | 30 - 40 | | 9.3 | | |
| | 40 - 43.5 | | 9.6 | | |
| Amplitude Unbalance | 10 - 20 | | 0.13 | | dB |
| | 20 - 25 | | 0.18 | | |
| | 25 - 30 | | 0.22 | | |
| | 30 - 40 | | 0.36 | | |
| | 40 - 43.5 | | 0.57 | | |
| VSWR (Port S) | 10 - 20 | | 1.6 | | :1 |
| | 20 - 25 | | 1.1 | | |
| | 25 - 30 | | 1.4 | | |
| | 30 - 40 | | 1.4 | | |
| | 40 - 43.5 | | 1.5 | | |
| VSWR (Port 1-2) | 10 - 20 | | 1.3 | | :1 |
| | 20 - 25 | | 1.2 | | |
| | 25 - 30 | | 1.3 | | |
| | 30 - 40 | | 1.4 | | |
| | 40 - 43.5 | | 1.4 | | |

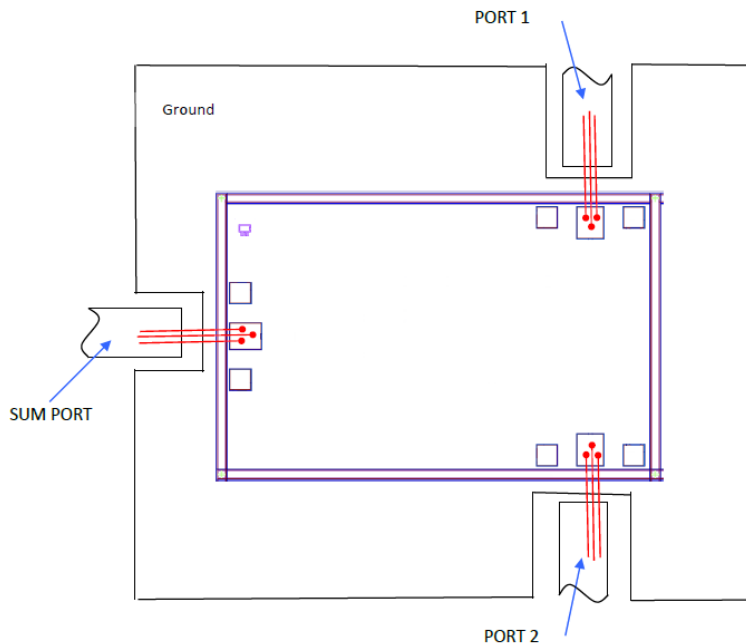
1. Tested in 2.5x3.5mm, Mini-Circuits 10-lead MCLP package.

Maximum Ratings

| Parameter | Ratings |
|-----------------------------|---------------|
| Operating Temperature | -40°C to 85°C |
| Power Input (as a splitter) | 1.25W |
| Internal Dissipation | 0.63W |
| DC Current | 300 mA |

Permanent damage may occur if any of these limits are exceeded.

Assembly Diagram



Assembly and Handling Procedure

1. Storage
Dice should be stored in a dry nitrogen purged desiccators or equivalent.
2. ESD
MMIC dice are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be opened in clean room conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickup tips or sharp antistatic tweezers to deter ESD damage to dice.
3. Die Attach
The Die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are DieMat DM6030HK-PT/H579 or Ablestik 84-1LMISR4. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total Die periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. It is recommended to use antistatic Die pick up tools only.
4. Wire Bonding
Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the dice gold bond pads. Thermosonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1 mil diameter. Bonds must be made from the bond pads on the Die to the package or substrate. All bond wires should be kept as short as low as reasonable to minimize performance degradation due to undesirable series inductance.

| Additional Detailed Technical Information | |
|---|---|
| <i>additional information is available on our dash board.</i> | |
| Performance Data | Data Table |
| | Swept Graphs |
| | S-Parameter (S3P Files) Data Set with and without port extension(.zip file) |
| Case Style | Die |
| Die Ordering and packaging information (Note 5) | <p>Quantity, Package Model No.</p> <p>Small, Gel - Pak: 5,10,50, KGD* EP2KA-DG+</p> <p>Medium†, Partial wafer: KGD*<790 EP2KA-DP+</p> <p>Large†, Full wafer EP2KA-DF+</p> <p>†Available upon request contact sales representative</p> <p>Refer to AN-60-067</p> |
| Environmental Ratings | ENV-80 |

*Known Good Dice ("KGD") means that the dice are taken from PCM good wafer and visually inspected in question have been subjected to Mini-Circuits while this is not definitive, it does help to provide a higher degree of confidence that dice are capable of meeting typical RF electrical parameters specified by Mini-Circuits.

ESD Rating**

Human Body Model (HBM): Class 2 (2000V to <4000V) in accordance with ANSI/ESD STM 5.1 - 2001

** Tested in 2.5x3.5mm, Mini-Circuits 10-lead MCLP package.

Additional Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp
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2 Way-0° Power Splitter/Combiner Die

EP2KA-D+

Typical Performance Data ⁽²⁾

TEST CONDITIONS: INPUT POWER = 0 dBm @Temperature = +25°C

| FREQ. (MHz) | TOTAL LOSS ⁽¹⁾ (dB) | | AMP. UNBAL. (dB) | ISOLATION (dB) | PHASE UNBAL. (deg.) | VSWR (:1) | | | |
|----------------|-----------------------------------|------|------------------------|-------------------|---------------------------|--------------|------|------|------|
| | S-1 | S-2 | | | | S | 1 | 2 | |
| 10 | 3.55 | 3.54 | 0.01 | 3.62 | 0.01 | 10 | 1.98 | 1.96 | 1.96 |
| 100 | 3.54 | 3.53 | 0.00 | 3.68 | 0.02 | 100 | 1.94 | 1.92 | 1.93 |
| 1000 | 3.56 | 3.56 | 0.00 | 4.01 | 0.24 | 1000 | 1.89 | 1.83 | 1.84 |
| 2000 | 3.59 | 3.60 | 0.02 | 4.50 | 0.42 | 2000 | 1.97 | 1.78 | 1.79 |
| 3000 | 3.61 | 3.64 | 0.03 | 5.14 | 0.42 | 3000 | 2.03 | 1.63 | 1.66 |
| 4000 | 3.68 | 3.69 | 0.01 | 5.80 | 0.39 | 4000 | 2.02 | 1.44 | 1.45 |
| 5000 | 3.82 | 3.80 | 0.03 | 6.58 | 0.54 | 5000 | 2.07 | 1.32 | 1.32 |
| 6000 | 3.83 | 3.78 | 0.05 | 7.66 | 0.94 | 6000 | 2.03 | 1.22 | 1.20 |
| 7000 | 3.68 | 3.63 | 0.05 | 8.86 | 1.33 | 7000 | 1.85 | 1.13 | 1.11 |
| 8000 | 3.63 | 3.61 | 0.02 | 9.48 | 1.57 | 8000 | 1.79 | 1.14 | 1.13 |
| 9000 | 3.72 | 3.70 | 0.02 | 9.63 | 1.78 | 9000 | 1.91 | 1.15 | 1.12 |
| 10000 | 4.02 | 4.01 | 0.01 | 10.37 | 2.07 | 10000 | 2.23 | 1.39 | 1.34 |
| 11000 | 4.12 | 4.15 | 0.03 | 11.87 | 2.20 | 11000 | 2.27 | 1.47 | 1.42 |
| 12000 | 3.79 | 3.83 | 0.03 | 13.60 | 2.10 | 12000 | 1.87 | 1.30 | 1.29 |
| 13000 | 3.58 | 3.57 | 0.01 | 14.68 | 2.14 | 13000 | 1.59 | 1.12 | 1.18 |
| 14000 | 3.71 | 3.67 | 0.04 | 15.01 | 2.45 | 14000 | 1.66 | 1.18 | 1.27 |
| 15000 | 3.98 | 3.94 | 0.04 | 15.91 | 2.83 | 15000 | 1.92 | 1.43 | 1.46 |
| 16000 | 4.01 | 3.99 | 0.02 | 17.57 | 3.10 | 16000 | 1.97 | 1.54 | 1.53 |
| 17000 | 3.75 | 3.74 | 0.01 | 19.81 | 3.28 | 17000 | 1.64 | 1.41 | 1.39 |
| 18000 | 3.51 | 3.50 | 0.01 | 22.31 | 3.40 | 18000 | 1.32 | 1.21 | 1.20 |
| 19000 | 3.47 | 3.46 | 0.01 | 23.72 | 3.54 | 19000 | 1.25 | 1.13 | 1.11 |
| 20000 | 3.56 | 3.54 | 0.03 | 24.32 | 3.73 | 20000 | 1.34 | 1.26 | 1.20 |
| 21000 | 3.56 | 3.52 | 0.04 | 25.12 | 4.01 | 21000 | 1.34 | 1.32 | 1.26 |
| 22000 | 3.48 | 3.44 | 0.05 | 25.72 | 4.34 | 22000 | 1.18 | 1.25 | 1.21 |
| 23000 | 3.45 | 3.43 | 0.02 | 25.47 | 4.60 | 23000 | 1.07 | 1.15 | 1.16 |
| 24000 | 3.47 | 3.45 | 0.01 | 23.97 | 4.71 | 24000 | 1.08 | 1.10 | 1.15 |
| 25000 | 3.54 | 3.51 | 0.03 | 22.24 | 4.63 | 25000 | 1.17 | 1.14 | 1.20 |
| 26000 | 3.76 | 3.67 | 0.09 | 21.26 | 4.75 | 26000 | 1.40 | 1.26 | 1.30 |
| 27000 | 3.96 | 3.82 | 0.14 | 21.31 | 5.34 | 27000 | 1.53 | 1.33 | 1.31 |
| 28000 | 4.01 | 3.89 | 0.12 | 21.52 | 5.89 | 28000 | 1.51 | 1.28 | 1.28 |
| 29000 | 4.10 | 4.01 | 0.09 | 21.00 | 5.97 | 29000 | 1.59 | 1.29 | 1.38 |
| 30000 | 4.38 | 4.23 | 0.15 | 20.51 | 6.07 | 30000 | 1.85 | 1.50 | 1.50 |
| 31000 | 4.64 | 4.44 | 0.20 | 20.75 | 6.71 | 31000 | 1.99 | 1.67 | 1.56 |
| 32000 | 4.75 | 4.57 | 0.18 | 21.28 | 7.47 | 32000 | 1.86 | 1.63 | 1.53 |
| 33000 | 4.72 | 4.59 | 0.13 | 21.56 | 7.87 | 33000 | 1.74 | 1.48 | 1.49 |
| 34000 | 4.69 | 4.60 | 0.09 | 22.08 | 8.04 | 34000 | 1.75 | 1.43 | 1.49 |
| 35000 | 4.71 | 4.63 | 0.08 | 23.36 | 8.10 | 35000 | 1.74 | 1.46 | 1.48 |
| 36000 | 4.62 | 4.53 | 0.09 | 25.11 | 8.26 | 36000 | 1.61 | 1.45 | 1.40 |
| 37000 | 4.48 | 4.38 | 0.10 | 26.88 | 8.50 | 37000 | 1.41 | 1.41 | 1.31 |
| 38000 | 4.39 | 4.28 | 0.10 | 28.97 | 8.82 | 38000 | 1.19 | 1.34 | 1.26 |
| 39000 | 4.31 | 4.22 | 0.09 | 31.13 | 9.11 | 39000 | 1.06 | 1.26 | 1.22 |
| 40000 | 4.30 | 4.22 | 0.08 | 32.02 | 9.29 | 40000 | 1.21 | 1.21 | 1.19 |
| 41000 | 4.51 | 4.45 | 0.06 | 30.83 | 9.34 | 41000 | 1.31 | 1.22 | 1.24 |
| 42000 | 5.06 | 4.98 | 0.07 | 29.26 | 9.33 | 42000 | 1.56 | 1.39 | 1.42 |
| 43000 | 5.61 | 5.50 | 0.11 | 28.80 | 9.44 | 43000 | 1.92 | 1.60 | 1.60 |
| 43500 | 5.73 | 5.60 | 0.13 | 28.96 | 9.60 | 43500 | 2.03 | 1.66 | 1.62 |

⁽¹⁾ Total Loss = Insertion Loss + 3dB splitter loss.

⁽²⁾ Test data of Die packaged in industry standard, 2.5x3.5 mm, 10-lead MCLP package



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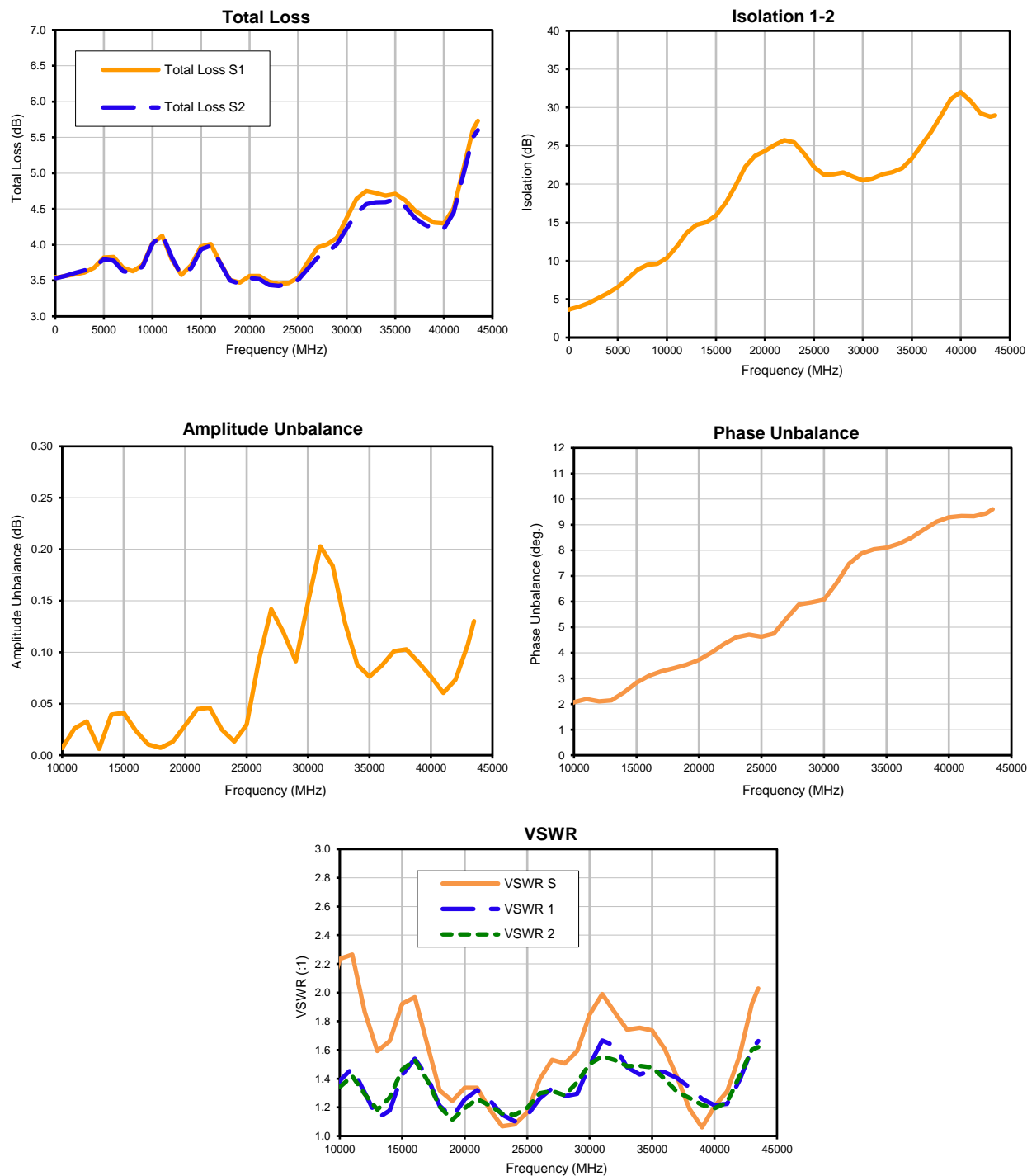
IF/RF MICROWAVE COMPONENTS

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2 Way-0° Power Splitter/Combiner Die

EP2KA-D+

Typical Performance Data⁽²⁾



⁽²⁾ Test data of Die packaged in industry standard, 2.5x3.5 mm, 10-lead MCLP package



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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification | Test/Inspection Condition | Reference/Spec |
|--------------------------------|--|--------------------------------------|
| Operating Temperature | -40° to 85° C or -40° to 105° C or -55° to 105° C or -45° to 105° C Ambient Environment | Refer to Individual Model Data Sheet |
| Storage Environment (Die) | -65° to 150°C | Individual Model Data Sheet |
| Storage Environment(Packaging) | -40° to 70°C and 40 to 60% humidity (In Factory Shipped Package) | |